

Electronic Supplementary Material (ESI) for RSC Advances.
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Supporting Information

In situ polymerization of graphene-polyaniline@ polyimide nanocomposite films with high EMI shielding and electrical properties

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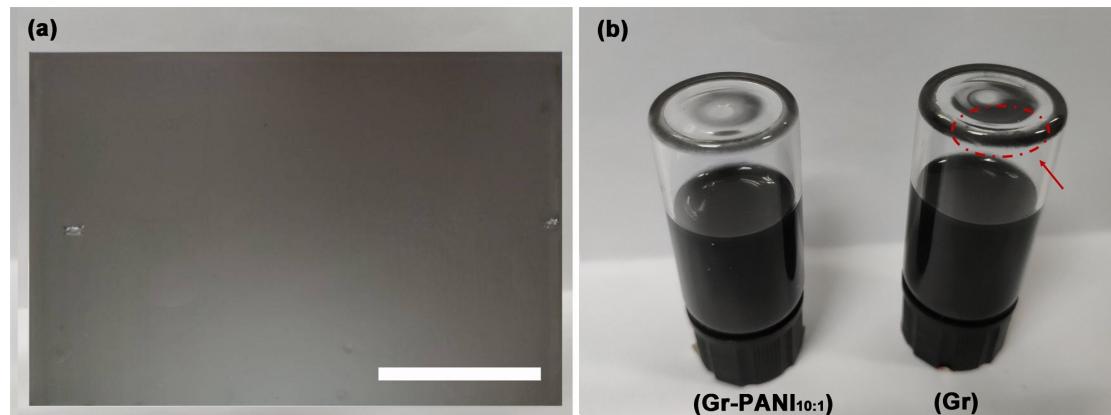


Fig. S1 (a) The large size 40%Gr-PANI_{10:1}@PI film (the scale bar is 10 cm); (b) Gr-PANI_{10:1} in NMP and Gr in NMP.

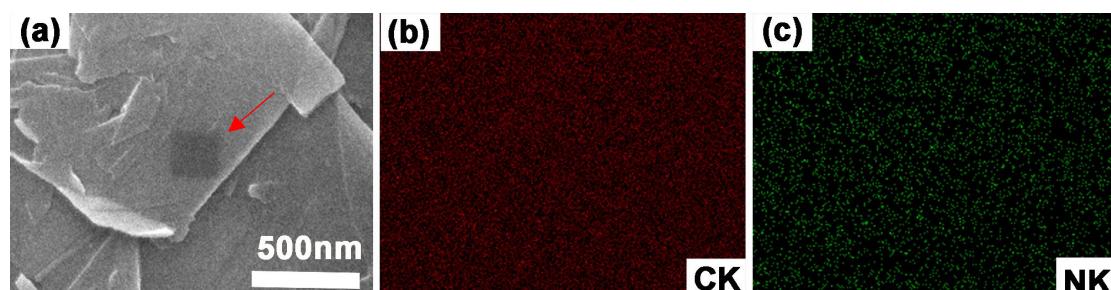


Fig. S2. SEM image of Gr-PANI_{10:1} and the EDS mapping of Gr-PANI_{10:1}.

Table S1 Element content of Gr-PANI_{10:1} composites.

Element (Gr-PANI _{10:1})	At%
CK	77.15
NK	22.19
OK	00.66

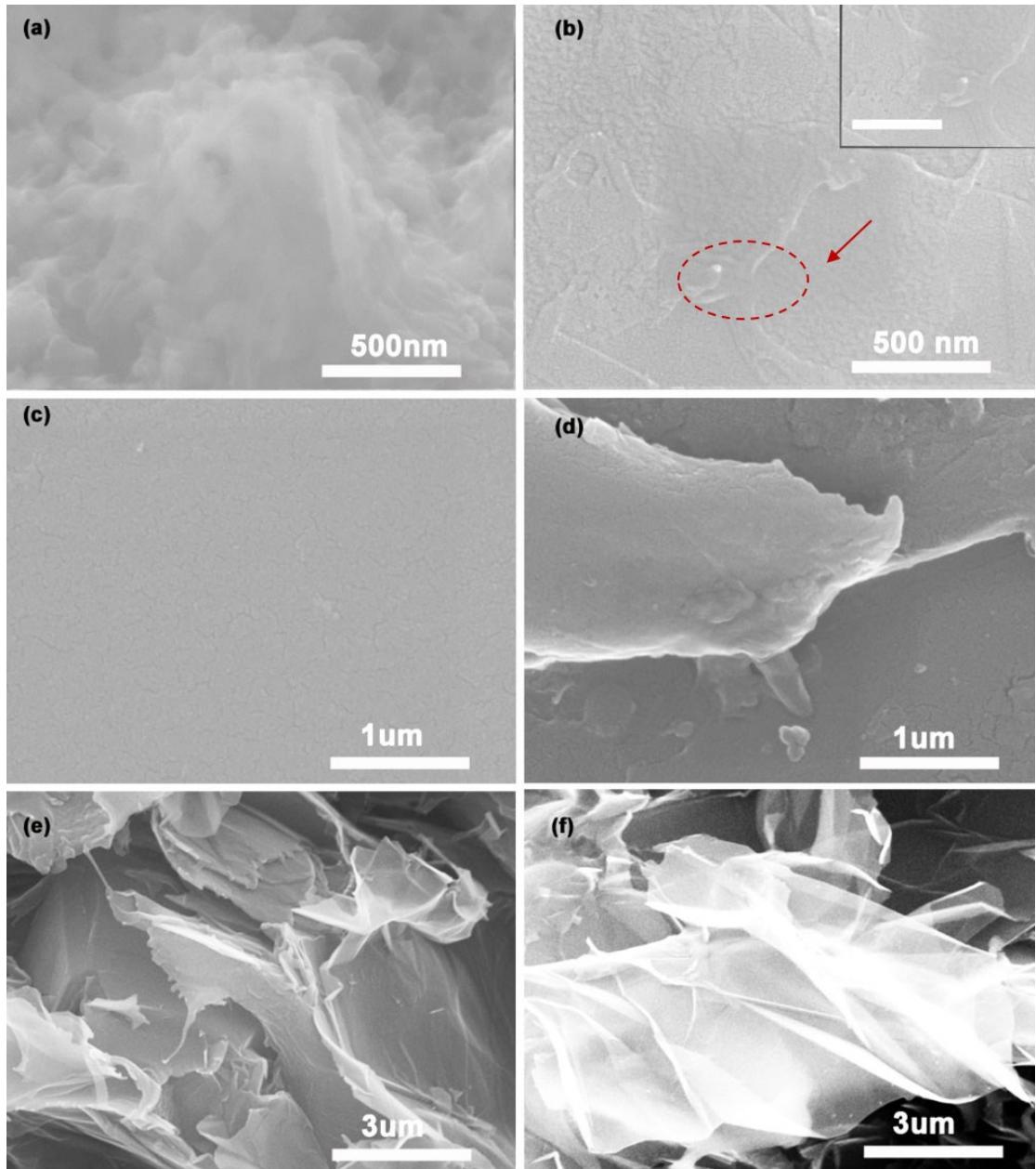


Fig. S3 The SEM images of (a, b,c,d) surface morphology of PANI, Gr-PANI_{5:1},Gr-PANI_{10:1}@PI and PI; The cross-section images (e, f) of Gr@PI and Gr-PANI_{10:1}@PI; The inset shows the magnification of the selected area and the scale bar is 0.1 um.

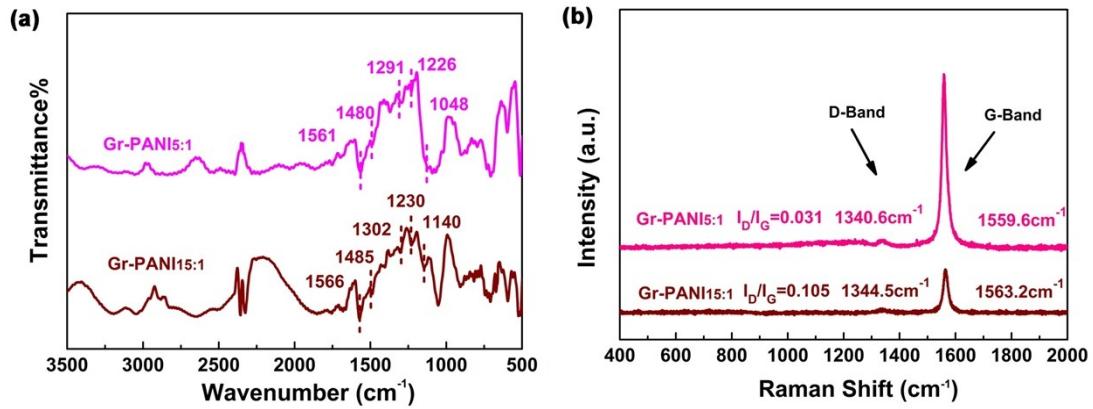


Fig. S4 (a) FTIR spectra of Gr-PANI_{5:1} and Gr-PANI_{15:1} composites; (b) Raman spectra of Gr-PANI_{5:1} and Gr-PANI_{15:1} composites.

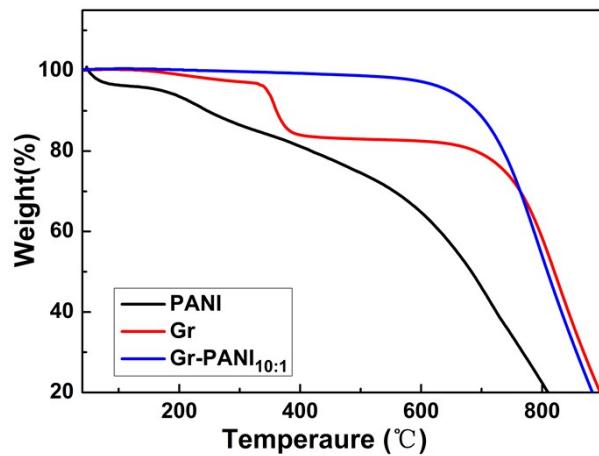


Fig. S5 TGA curves of pure PANI, Gr and Gr-PANI_{10:1} composites.

Fig. S5 shows TGA curves of pure PANI, Gr and Gr-PANI_{10:1} composites. The 15 wt% weight loss temperatures of the PANI, Gr and Gr-PANI_{10:1} are 328.5 $^{\circ}\text{C}$, 383.1 $^{\circ}\text{C}$, and 717.5 $^{\circ}\text{C}$, respectively. Meanwhile, the residual weight at 700 $^{\circ}\text{C}$ for the Gr-PANI_{10:1} is remarkably enhanced from 79.3% (pure Gr) to 86.8%, indicating that the Gr-PANI_{10:1} shows superior thermal stability. The TGA curve of Gr-PANI_{10:1} is the superposition of Gr and PANI. The weight ratio of PANI in Gr-PANI_{10:1} is calculated by the following equation (1):

$$\text{wt\%}(PANI)=1-\frac{\Delta W_2 - \Delta W_1}{\Delta W_2 - \Delta W_3} \times 100\% \quad (1)$$

where the ΔW_1 , ΔW_2 and ΔW_3 represent the weight loss of Gr-PANI_{10:1}, PANI and Gr from 40 to 800 $^{\circ}\text{C}$. According to the TGA data, the PANI content in Gr-PANI_{10:1} is 12.5 wt%, which is close to the theoretical value.

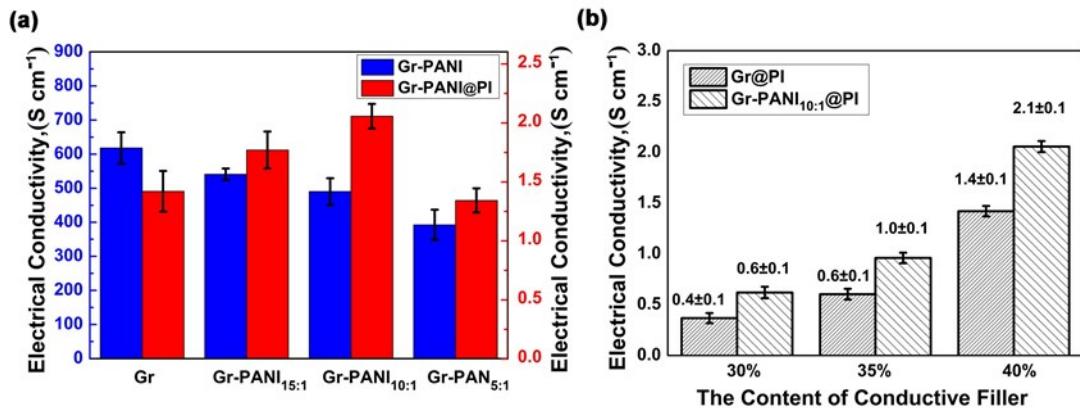


Fig. S6 Electrical conductivity of (a) Gr-PANI and 40%Gr-PANI@PI with different mass ratios of Gr to PANI; (b) Gr@PI and Gr-PANI_{10:1}@PI with different filler contents.

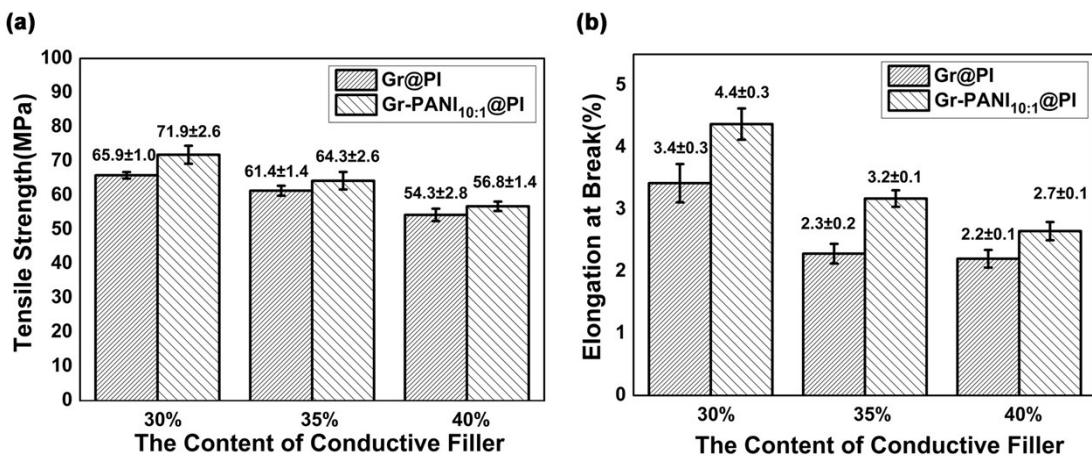


Fig. S7 The mechanical properties of Gr@PI and Gr-PANI_{10:1}@PI with different filler contents
(a) the tensile strength; (b)the elongation at break.

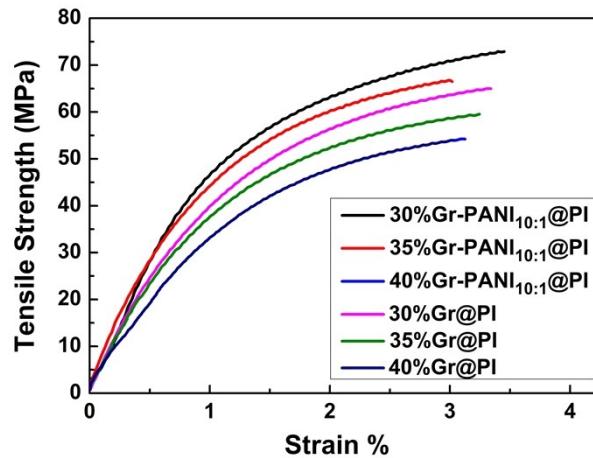


Fig. S8 Typical stress-strain curves of pure Gr@PI and Gr-PANI_{10:1}@PI films with different filler contents.



Fig. S9 Experiment setup for EMI shielding measurement: vector network analyzer.

Table S2 EMI shielding performance of various carbon-based polymer composite films

Materials	Content (wt%)	Thickness (mm)	EMI SE _T (dB)	EMI SSE value (dB·cm ² g ⁻¹)	Ref
PS/graphene	30.0	2.50	~17.3	~256.3	1
PEI/graphene foam	10.0	2.30	~11.0	~164.9	2
PU/MWCNT	22.0	0.10	~20.0	/	3
WPU/CNT	76.2	0.32	~49.0	~3408.0	4
PVDF/graphene	15.0	0.10	/	~1265.0	5
Phenolic/rGO	70.0	0.30	~43.4	/	6
PI/graphene	8.0	0.50	13.7–14.9	~693.0	7
PI/graphene foam	16.0	0.80	17.0–21.0	~75.0	8
PE/graphene	15.0	1.00	~33.0	/	9
Cellulose/CNT	40.0	0.15	~35.0	~1372.4	10
WPU/CNT	76.2	2.30	~35.0	~2143.0	11
Gr-PANI _{10:1} @PI	40.0	0.04	~21.3	~4096.2	This work

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